L ,	Hits	Search Text	DB	Time stamp
Number -	428	(MIM or (metal adj insulator adj metal)) adj capacitor	USPAT; US-PGPUB; EPO; JPO; DERWENT;	2002/03/19 11:52
-	21	((MIM or (metal adj insulator adj metal)) adj capacitor) and (etch adj stop)	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2002/03/19 14:37
-	6987	stop adj layer	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2002/03/19 14:39
-	20	(stop adj layer) and ((MIM or (Metal adj insulator adj metal)) adj capacitor)	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/19 14:46
-	1433	substrate and (dielectric adj layer) and ((stop adj layer) or (etch adj back)) and (metal adj layer)	USPĀT;	2002/03/19 14:49
-	230	(substrate and (dielectric adj layer) and ((stop adj layer) or (etch adj back)) and (metal adj layer)) and (dual adj damascene)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/19 14:49
-	4	((substrate and (dielectric adj layer) and ((stop adj layer) or (etch adj back)) and (metal adj layer)) and (dual adj damascene)) and MIM	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/19 14:53
-	4041	мім	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/19 14:54
-	76	MIM and ((stop adj layer) or (etch adj back))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/03/19
-	730	(dielectric adj layer) near3 copper	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/19
-		((dielectric adj layer) near3 copper) and ((dielectic adj layer) near3 substrate)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/19 15:37
-	6	((dielectric adj layer) near3 copper) and MIM	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/03/19 15:38
-	567	(stop adj layer) near3 (dielectric adj layer)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2002/03/19 15:43

-	40	((stop adj layer) near3 (dielectric adj		2002/03/19
		layer)) and (copper near4 (dielectric adj		16:11
		layer))	EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	1668	dual adj damascene	USPAT;	2002/03/19
				16:11
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
_	486	(dual adj damascene) and (stop adj layer)	USPAT;	2002/03/19
			US-PGPUB;	16:12
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	0000/00/10
-	395	((dual adj damascene) and (stop adj	USPAT;	2002/03/19
		layer)) and (dielectric adj layer)	US-PGPUB;	16:13
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	2002/02/16
-	58	(((dual adj damascene) and (stop adj	USPAT;	2002/03/19
		layer)) and (dielectric adj layer)) and	US-PGPUB;	16:14
		(etch adj back)	EPO; JPO;	
			DERWENT;	
			IBM_TDB	